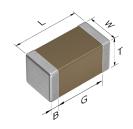
积层贴片陶瓷片式电容器

C1608X5R1C475K080AC

RoHS Reach Halogen Free Pb Free

| 交货型号 | C1608X5R1C475KT**** |
|------|---------------------|
| 用途 | 一般等级 |
| 特点 | General 一般(~75V) |
| 系列 | C1608 [EIA 0603] |
| 状态 | 量产体制 |



| 尺寸 | | |
|-----------------|-------------------------------------|--|
| 长度(L) | 1.60mm ±0.10mm | |
| 宽度(W) | 0.80mm ±0.10mm | |
| 厚度(T) | 0.80mm ±0.10mm | |
| 端子宽度(B) | 0.20mm Min. | |
| 端子间隔(G) | 0.30mm Min. | |
| 推荐焊盘布局(PA) | 0.70mm to 1.00mm(Flow Soldering) | |
|)E47.件血加加 (LA) | 0.60mm to 0.80mm (Reflow Soldering) | |
| 推荐焊盘布局(PB) | 0.80mm to 1.00mm(Flow Soldering) | |
| 1世行。序血和/p (t D) | 0.60mm to 0.80mm (Reflow Soldering) | |
| 推荐焊盘布局(PC) | 0.60mm to 0.80mm(Flow Soldering) | |
| 1世行丹益仰四(にし) | 0.60mm to 0.80mm(Reflow Soldering) | |

| 电气特性 | | |
|-------------|---------------------------|--|
| 电容 | $4.7\mu\mathrm{F}\pm10\%$ | |
| 额定电压 | 16VDC | |
| 温度特性 | $X5R(\pm 15\%)$ | |
| 耗散因数(Max.) | 10% | |
| 绝缘电阻 (Min.) | 21ΜΩ | |

| | 其他 |
|--|---------------|
| 焊接方法 | 流体 |
| / | 回流 |
| AEC-Q200 | NO |
| 包装形式 | 纸编带 (180mm卷筒) |
| 包装个数 | 4000pcs |

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

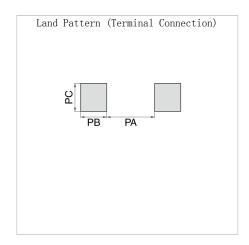
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Associated Images



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